Hard soldering, compact, and slim (1.25mm) are realized

Typical Specifications

Initial contact resistance

Rating (max.)

Rating (min.)

Travel (mm)

Items



Specifications

50mA 12V DC

 $10 \mu A 1 V DC$

 $100m\Omega$ max.

0.2

ĺ		1.00	
Product No.		Operating force	Operating direc
	Product Line Side push type		

Product No.	Operating force	Operating direction	Operating life	Guide bosses	Minimum order unit (pcs.)		
1 loddor Hol			(5mA 5V DC)		Japan	Export	
SKSCLCE010	1.6N			Without		5,000	
SKSCLAE010	2.2N	Side push	100,000 cycles -		5.000		
SKSCLDE010	1.6N			With	5,000		
SKSCLBE010	2.2N				VVILN		

With ground terminal type

Product No.	Operatingforce	Operating direction	Operating life	Guide bosses	Minimum order unit (pcs.)	
TTOUUGENO.	Operatingiorce		(5mA 5V DC)	Oulde bosses	Japan	Export
SKSCPCE010	1.6N		100,000 cycles -	Without	5,000	5,000
SKSCPAE010	2.2N	Side push				
SKSCPDE010	1.6N			With		
SKSCPBE010	2.2N					

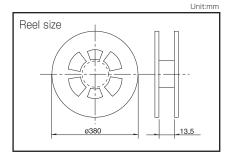
Packing Specifications

Taping

Num	ber of packages (Tape width	Export package	
1 reel	1 case / Japan	1 case / export packing	(mm)	measurements (mm)
5,000	50,000	50,000	12	395×395×205

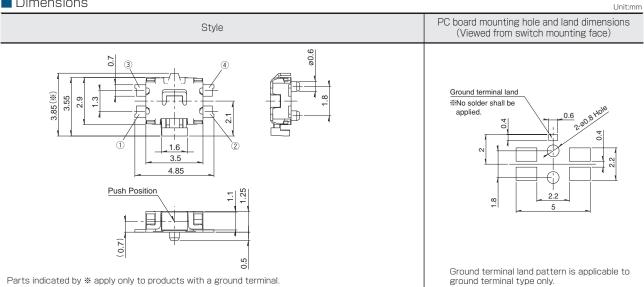
Note

For reels of 330mm diameter, please inquire.

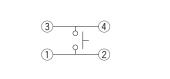




Dimensions



Circuit Diagram





TACT Switch[™] List of Varieties

	Туре	Sł	narp Feeling Ty	pe		ç	Soft Feeling Typ	be	
			Surface Mount		Snap-in		Surfac	e Mount	1
	Series	SKSC	SKRT	SKRH	SKPF	SKPS	SKPM	SKPG	SKPR
	Photo	-		4					9
	Features	Low-profile	_	4-direction switch +push switch	High operation force Long travel	Low contac	t resistance	_	High operation force Low contact resistance
١	Vater-proof	_	_	_	_	_	_	_	-
	Dustproof	_	_	_	_	_	_	_	_
I	P standard	_	_	_	_	_	_	_	_
Operatii	Top push	_	_	•	•	٠	•	•	•
directio		•	•	•	_	_	_	_	_
	W	3.5	4.5	7.35	8	5	.9	6.6	7.5
Dimensio (mm)		3.55	3.4	7.5	9	(3	6.3	7.8
(11111)	Н	1.25	3.3	5	10		5		6.5
	Contact	_	_	_	Carbon	Sil	ver	Carbon	Silver
Operatio force coverag	2N to 3N	1	\$	See the relevant pages for respective product descriptions		\$	Ţ	1	
Т	ravel (mm)	0.	2	1.75	See the relevant pages for respective product descriptions	1.05	1	1.3	
Gro	ound terminal	0	•	•	_	—	_	_	_
Operat	ing temperature range	−30℃ to +85℃	-40℃ to +90℃	−40°C to +85°C	C −40℃ to +90℃		1		
Au	tomotive use	_	_	_	•	•	•	•	•
	Life Cycle								
	Rating (max.) (Resistive load)			ImA I DC			mA DC	5mA 12V DC	50mA 16V DC
Electrical	Rating (min.) (Resistive load)	10μΑ 1V DC							<u> </u>
performance	Insulation resistance	100MΩ min. 100V DC 1min.							
	Voltage proof	100V AC 1min.	250V AC 1min.	100V AC 1min.	250V AC 1min.				
Durrel	Vibration	10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2 hours respectively							
Durability	Lifetime	Shall be in accordance with individual specifications.							
	Cold	-40°C 96h				-40°C 1,000h -40°C 96h		-40°C 1,000h	
Environmental performance	Dry heat		90°C 96h			90°C 1,000h 90°C 96h		90℃ 1,000h	
	Damp heat	60°C, 90 to 95%RH 96h				60°C, 90 to 9	5%RH 1,000h	60°C, 90 to 95%RH 96h	60°C, 90 to 95%RH 1,000h
	Page	225	227	405	230	231	232	233	234

 $\ensuremath{\mathsf{W}}$: Width. The most outer dimension excluding terminal portion.

 D : Depth. The most outer dimension excluding terminal portion. H : Height. The minimum dimension if there are variances.

 TACT Switch[™] Soldering Conditions
 235

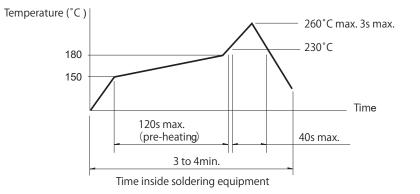
 TACT Switch[™] Cautions
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Notes

1. The automotive operating temperature range to be individually discussed upon request.

2. • Indicates applicability to all products in the series, while \bigcirc indicates applicability to some products in the series.

Condition for Reflow Available for Surface Mount Type. Temperature profile



Notes

1. Please confirm the specifications of our product for the detailed condition.

2. Soldering conditions differ depending on reflow soldering machines.

Prior verification of soldering condition is highly recommended.

Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHH Series

ltems	Condition		
Flux built-up	Mounting surface should not be exposed to flux		
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110 $^\circ\!\mathrm{C}$ max.		
Preheating time	60s max.		
Soldering temperature	260°C max.		
Duration of immersion	5s max.		
Number of soldering	2times max.		

SKHL Top Push Type, SKQJ Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	45s max.
Soldering temperature	255℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

Notes

1. Prevent flux penetration from the top side of the TACT SwitchTM.

2. Switch terminals and a PC board should not be coated with flux prior to soldering.

3. The second soldering should be done after the switch is stable with normal temperature.

4. Use the flux with a specific gravity of min 0.81.

(EC-195-8 by TAMURA CORPORATION, or equivalents.)

Manual Soldering

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKHH, SKHW Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKTD, SKTG, SKQJ, SKSN Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.